



Broadcom Becomes First to Enable the Android Mobile Platform to Support Wireless Connectivity 'Combo Chips'

Access to Broadcom's BCM4325 Drivers Enables the Android Ecosystem to Support the Most Advanced Wireless Connectivity Solutions

IRVINE, Calif. - February 5, 2009 - Broadcom Corporation (Nasdaq: BRCM), a global leader in semiconductors for wired and wireless communications, today announced that the software that controls its industry-leading Wi-Fi®/Bluetooth®/FM combination solution is a standard component of the latest Android operating system. This is the first time that the Android platform includes native support for a multi-functional wireless connectivity solution (or "combo" chip). Open access to portions of Broadcom's combo drivers provides Android developers with a head-start in designing mobile devices and applications that utilize the best in wireless connectivity solutions.

Wi-Fi, Bluetooth and FM technologies are becoming increasingly common in today's mobile phones, enabling a variety of popular media and data applications. The current generation of Android-based handsets features both Bluetooth and Wi-Fi, but uses discrete components. The Broadcom® BCM4325 is the best-selling Bluetooth and Wi-Fi combo chip on the market, offering best-in-class space, power, cost and coexistence features. Adding Broadcom's BCM4325 drivers to the Android platform simplifies the integration of these connectivity technologies and accelerates platform development cycles.

"Two of the most exciting trends in the handset industry are the growing popularity of Android and the transition to combo chips for connectivity," said Chris Bergey, Director of Broadcom's Embedded WLAN line of business. "As a founding member of the Open Handset Alliance, we are committed to advancing the Android platform by contributing our software and facilitating greater access to our combination chips in the open source community. We expect a plethora of products and applications to evolve from the connected Android platform in the not-so-distant future."

The inherent benefits of multi-radio integration have changed the way many handset manufacturers think about connectivity features, which is driving significant growth for combo chips. According to IDC, a global market intelligence firm, combo chips will account for nearly 60 percent of connectivity solutions that ship into mobile phones by 2012. Broadcom was the first chipmaker to successfully combine Wi-Fi, Bluetooth and FM technologies on a single silicon die, and now offers the industry's largest portfolio of wireless combo chips.

About the Android Platform

Developed by the Open Handset Alliance (OHA), Android is the first free and open mobile platform. It includes everything a manufacturer or operator needs to build a mobile phone, including an operating system, middleware and key mobile applications. Developers can take advantage of the comprehensive software stack to develop innovative applications and compelling services. By contributing to the Android platform, members of the OHA can make it easier for developers to distribute and commercialize their applications.

About Broadcom

Broadcom Corporation is a major technology innovator and global leader in semiconductors for wired and wireless communications. Broadcom products enable the delivery of voice, video, data and multimedia to and throughout the home, the office and the mobile environment. We provide the industry's broadest portfolio of state-of-the-art system-on-a-chip and software solutions to manufacturers of computing and networking equipment, digital entertainment and broadband access products, and mobile devices. These solutions support our core mission: Connecting everything®.

Broadcom is one of the world's largest fabless semiconductor companies, with 2008 revenue of \$4.66 billion, and holds over 3,100 U.S. and over 1,400 foreign patents, more than 7,600 additional pending patent applications, and one of the broadest intellectual property portfolios addressing both wired and wireless transmission of voice, video, data and multimedia.

Broadcom is headquartered in Irvine, Calif., and has offices and research facilities in North America, Asia and Europe. Broadcom may be contacted at +1.949.926.5000 or at www.broadcom.com.

Cautions regarding Forward Looking Statements:

All statements included or incorporated by reference in this release, other than statements or characterizations of historical fact, are forward-looking statements. These forward-looking statements are based on our current expectations, estimates and

projections about our industry and business, management's beliefs, and certain assumptions made by us, all of which are subject to change. Forward-looking statements can often be identified by words such as "anticipates," "expects," "intends," "plans," "predicts," "believes," "seeks," "estimates," "may," "will," "should," "would," "could," "potential," "continue," "ongoing," similar expressions, and variations or negatives of these words. Examples of such forward-looking statements include, but are not limited to, the products and applications that will evolve from the connected Android platform and the demand for wireless combination chips. These forward-looking statements are not guarantees of future results and are subject to risks, uncertainties and assumptions that could cause our actual results to differ materially and adversely from those expressed in any forward-looking statement.

Important factors that may cause such a difference for Broadcom in connection with software drivers for its combination chips include, but are not limited to:

- the rate at which our present and future customers and end-users adopt Broadcom's combination solutions for mobile devices;
- trends in the consumer electronics market in various geographic regions, including seasonality in sales of consumer products into which our products are incorporated, and possible disruption in commercial activities related to terrorist activity or armed conflict in the United States and other locations;
- the gain or loss of a key customer, design win or order; and
- competitive pressures and other factors such as the qualification, availability and pricing of competing products and technologies and the resulting effects on sales and pricing of our products.

Additional factors that may cause Broadcom's actual results to differ materially from those expressed in forward-looking statements include, but are not limited to the list that can be found at http://www.broadcom.com/press/additional_risk_factors/Q12009.php.

Our Annual Report on Form 10-K, subsequent Quarterly Reports on Form 10-Q, recent Current Reports on Form 8-K, and other Securities and Exchange Commission filings discuss the foregoing risks as well as other important risk factors that could contribute to such differences or otherwise affect our business, results of operations and financial condition. The forward-looking statements in this release speak only as of this date. We undertake no obligation to revise or update publicly any forward-looking statement, except as required by law.

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